Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

DF61 Series



Features

1.Reinforced Swing Lock Structure

Our unique swing-lock structure cradles the wire side plug and resists the plug from becoming disengaged due to handling strain or loads.

2.Header Lock Improves Plug Retention

During mating, the header lock engages with the plug assembly. The lock is reinforced with metal which adds strength to the lock and increases the retention between the header and the plug.

3.Compact Size- High Voltage

The compact 2.2 mm pitch connector has a voltage rating of 350V due to the long creep distance.

4.Solder Wicking Prevention

Header is molded in one piece. This ensures a tight fit between the contact and the header and prevents solder wicking.

5. High Current of MAX 5 Amps (AWG22)

A highly conductive material is used for the contacts. The material provides for a high current flow by reducing the contact resistance.

Applications

Digital cameras, digital video cameras, LED lights, laptop computers, tablet computers, portable devices, power supply equipment, etc.



The protrusion on the bottom side of the socket fits into a corresponding recess on the header. This aligns the socket into the correct mating position.

Before Mating



After Mating

The Header pushes down the protrusion of the socket and locks it in place.

The metal fitting is partly molded in the header's housing lock.

nolded Tensile strength of the cable: lock. 10N or greater



■Product Specifications

Ratings	Current rating	3.2A (with AWG26) 4A (with AWG24) 5A (with AWG22)	Operating Temperature Range Operating Humidity Range	-35~85℃ 20~80%	(Note 1)
	Voltage rating	AC/DC 350V	Storage Temperature Range Storage Humidity Range	-10~60℃ 40~70%	(Note 2) (Note 2)
Items	Specific	cations	Cond	itions	
1.Insulation resistance	1000MΩ or greater		Measured at DC 500V		
2.Withstanding voltage	No flashover or breakdo	own	AC1700V applied for one minu	te	
3.Contact resistance	10mΩ or less		Measured at 20mV or less, 1mA		
	No electric outage of 1μ s or more		Frequency 10-55Hz, half amplitude 0.75 mm, 10 cycles for		
4.Vibration resistance			each of 3 directions		
5.Shock resistance	No electric outage of 1	us or more	Acceleration 490 m/s ² , 11ms; h directions	alf sin wave: 3 e	ach for 3
6.Humidity resistance	Contact resistance 20m resistance 500MΩ or gr	,	Temperature 40 \pm 2°C, humidit	y 90-95%, left fo	r 96 hours
7.Temperature cycle	Contact resistance 20m resistance 500MΩ or gr		5 cycles (-55℃: 30 minutes → minutes → 5-35℃: 2-3 minutes		tes → 85℃: 30
8.Insertion/extraction life	Contact resistance20m	Ω or less	Insertion/extraction: 30 times		
9.Solder heat resistance	No melting of resin part	affecting performance	Reflow: Per recommended tem Hand solder: Manual soldering		or 3 seconds

(Note 1) Includes temperature elevation by conduction.

(Note 2) The term "storage" refers to the long-term storage conditions of unused connectors before PCB mounting. The operating temperature range applies to connectors in non-conduction state after PCB mounting or those in temporary storage during transportation, etc.

(Note 3) The above specifications are representative for this series. Please refer to "delivery specifications" for official individual agreement.

Materials

Product	Part	Material	Treatment	Specification
Header	Insulator	LCP resin	Red	UL94V-0
neader	Contact	Brass	Tin plated	
Crimp Socket	Insulator	PBT	Red	UL94V-0
Crimp contact	Contact	Copper Alloy	Tin plated	

Product Number Structure

See Pages 4-6 of this catalog to select and order specific items.

●Header <u>DF</u>	<u>61</u>	-	*	<u>P</u>	_	<u>2.2</u>	<u>V</u>	-
_			•			•		
 Series N 	vame:	DF						5 Pitch: 2.2mm
2 Series N	No.: 61							6 Termination form
3 Numbe	r of co	ontacts	s: 2					V: SMT straight type
4 Type of connector								
P: Head	der							

Crimp Housing

DF	61	-	*	S	—	2.2	С	
1	2		3	4		5	6	-
1 Series	Name:	DF						5 Pitch: 2.2mm
2 Series	s No.: 61							6 Termination form
3 Numb	er of co	ontacts	s: 2					C: Crimp case
4 Туре	of conne	ector						
S: So	cket							

Contact DF 61 - 2628 SCF O

2628:AWG# 26-28

2226:AWG# 22-26

Porm Type/Package Type SCF: Socket crimp contact/reel DF61 Series
Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

Straight Header (SMT)





Recommended PCB Dimensions(t=1mm)





[Specification No.]
(21):Tin plated, emboss package, mold color: red
(22):Tin plated, emboss package, mold color: yellow
(23):Tin plated, emboss package, mold color: beige

			Unit : mm
Product Number	HRS No.	No. of contacts	Color
DF61-2P-2.2V(21)	CL666-5001-1-21	2	Red
DF61-2P-2.2V(22)	CL666-5001-1-22	2	Yellow
DF61-2P-2.2V(23)	CL666-5001-1-23	2	Beige

Note: For embossed package products, please order in full reel quantities. (1 reel = 3000 pcs.).

Reel Dimensions



Socket







[Specification No.]

(11): 1,000 connectors per pack, mold color: red(12): 1,000 connectors per pack, mold color: yellow(13): 1,000 connectors per pack, mold color: white

			Unit : mm
Product Number	HRS No.	No. of contacts	Color
DF61-2S-2.2C(11)	CL666-5002-4-11	2	Red
DF61-2S-2.2C(12)	CL666-5002-4-12	2	Yellow
DF61-2S-2.2C(13)	CL666-5002-4-13	2	White

Note: Please order by full packs (1,000 pcs./pack)

Crimp contact



Product Number	HRS No.	Туре	Quantity	Treatment
DF61-2628SCF	CL666-5005-2-00	Reel contact	18,000 contacts per reel	Tin plated
DF61-2226SCF (41)	CL666-5004-0-41	Reel contact	18,000 contacts per reel	Tin plated

(Note1) Please order in full reel quantities. (1 reel = 18,000 pcs.).

•Applicable Wire (Tin plated soft copper wire)

Conductor Size	Coating Diameter
AWG# 26-28	<i>∳</i> 0.7mm - 1.1mm
AWG# 22-26	∮ 1.0mm - 1.3mm

Note: Please consult with our a Hirose sales representative when using wires other than those recommended below.

●Applicable wires: UL10368 AWG#22, AWG#24, AWG#26, AWG#28

Strip Length 1.3 - 1.7mm

Applicable Crimping Tools

Types	Product Number	HRS No.	Applicable Contact
Applicator	AP105-DF61-2628S	CL901-4632-6-00	DF61-2628SCF
Applicator	AP105-DF61-2226S	CL901-4621-0-00	DF61-2226SCF
Press Unit	CM-105	CL901-0005-4-00	
Hand Tool	HT305/DF61-2628S	CL550-0305-5-00	DF61-2628SCF
	HT305/DF61-2226S	CL550-0304-2-00	DF61-2226SCF
Extraction Tool	DF-C-PO(B)	CL550-0179-2-00	DF61-2628SCF, DF61-2226SCF

Note: Problems resulting from the use of non-authorized tools will not be warranted.

Operating Precautions

1. Recommended Temperature Profile						
(Lead-free soldering possible)	10sec MAX					
	250 — — — — — — — — — — — — — — — — — — —					
	220°C					
	200					
	$\overline{\Theta}$ 180°C					
	َلَّ <u>الْحَ</u> 150					
	$ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $					
	50					
	90~120sec 60sec MAX					
	PRE-HEATING TIME SOLDERING TIME					
	[Applicable Conditions]					
	1. Peak Temperature: MAX 250°C					
	 Heated Area: 220°C or above, within 60 sec. Pre-heating Area: 150-180°C, 90-120 sec. 					
	4. Number of Operation: Twice or less					
	* The contact lead area was measured.					
	The conditions may change depending on the types and manufacturers of cream solder, PCB size, and conditions of other materials used for soldering.					
	Please fully check the soldering condition before use.					
	[Remarks 1] This temperature profile is our recommended value.					
2. Recommended Hand Solder Conditions	Soldering iron temperature: 350 \pm 10 $^\circ\!C$, soldering time: within 3 seconds					
3. Recommended Screen Thickness, Aperture Opening Rate (Pattern Area Ratio)	Thickness 0.1 mm, aperture opening rate: 100%					
4. PCB Warpage						
	Max 0.02 mm at the center of connector with the both edges of the connector as the baseline					
5. Cleaning Condition						
	Cleaning with IPA is possible. (Cleaning is not recommended as it may change the feel of insertion/extraction, etc. Please consult with us when using other types					
	of cleaning agents.)					
6. Precautions	■ In order to maintain the performance reliability, do not insert the crimp contact					
	into the crimp socket at a slant angle.					
	■ Insertion/extraction of the connector while not mounted to the PCB may cause					
	 breakage or deformation to the contact. Extracting the connector by holding the cable could result in a breakage. 					
	 Do not apply flux at the time of hand soldering, as it may result in flux rise. This product may have clightly different hus on molded items, however, they do 					
	This product may have slightly different hue on molded items, however, they do not affect the product performance.					
	■ See the separate"DF59 Insertion/Extraction Procedure Manual" for handling					
	precautions at the time of insertion and extraction.					





HIROSE ELECTRIC CO.,LTD.

6-3,Nakagawa Chuoh-2-Chome,Tsuzuki-Ku,Yokohama-Shi 224-8540,JAPAN TEL: +81-45-620-3526 Fax: +81-45-591-3726 http://www.hirose.com http://www.hirose-connectors.com

The characteristics and the specifications contained herein are for reference purpose. Please refer to the latest customer drawings prior to use. The contents of this catalog are current as of date of 04/2013. Contents are subject to change without notice for the purpose of improvements.